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Docket No.: YPL-0018

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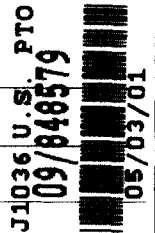
To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):
YOUNG HOON PARK

2. Name and address of receiving party(ies):

Name: **IPS LTD.**

Internal Address: **33 Jije-dong, Pyungtaek-si,
Kyungki-do, Korea**



Additional names(s) of conveying party(ies) Yes No

Street Address:

29848579

City: _____ State: _____ ZIP: _____

3. Nature of conveyance:

- Assignment Merger
- Security Agreement Change of Name
- Other _____

Additional name(s) & address(es) attached? Yes No

Execution Date: **April 4, 2001**

4. Application number(s) or registration numbers(s):

If this document is being filed together with a new application, the execution date of the application is: **April 4, 2001**

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: **Daniel F. Drexler**

Internal Address: **Cantor Colburn LLP**

Street Address: **55 Griffin Road South**

City: **Bloomfield** State: **CT** ZIP: **06002**

6. Total number of applications and patents involved: **1**

7. Total fee (37 CFR 3.41):.....\$ **40.00**

- Enclosed - Any excess or insufficiency should be credited or debited to deposit account
- Authorized to be charged to deposit account

8. Deposit account number:

06-1130

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Daniel F. Drexler, Reg. No. 47,535

Name of Person Signing

Signature

May 03, 2001

Date

Total number of pages including cover sheet, attachments, and document: **3**

PATENT

REEL: 011776 FRAME: 0924

ASSIGNMENT

WHEREAS, I/WE

Yöung-Hoon Park residing at 33 Jije-dong, Pyungtaek-si, Kyungki-do, Rep. of Korea
_____, residing at _____;
_____, residing at _____;
_____, residing at _____;
_____, residing at _____;
_____, residing at _____;

have invented certain new and useful improvements in:

Title: Apparatus and method for depositing thin film on wafer using
atomic layer deposition

for which I/WE have filed an application for Letters Patent of the United States;

AND WHEREAS, IPS LTD., a corporation organized
and existing under the laws of Rep. of Korea, having a place of business at
33 Jije-dong, Pyungtaek-si, Kyungki-do, Rep. of Korea
is desirous of acquiring an interest in the United States and all foreign countries, in and to the said
invention and the Letters Patent to be obtained therefor;


NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that, for and in
consideration of one (\$1.00) dollar to me/us in hand paid, and other good and valuable
considerations, the receipt of all of which is hereby acknowledged, I/We, the said

Young-Hoon Park, _____,
_____ and _____;

have sold, assigned and transferred, and by these presents do sell, assign and transfer unto said
IPS LTD., the entire right, title and interest in and to said invention in the United
States and in all foreign countries, including priority rights, as fully set forth and described in said
application; and I/We do hereby authorize and request the Commissioner of Patents to issue said

Letters Patent on said application and any and all Letters Patent that may be issued upon any and all revivals, refilings, continuations, continuation-in-part, divisions and reissues thereof, to the said _____ IPS LTD. _____, as assignee of the entire right, title and interest in and to the same, for the sole use and behoof of _____ IPS LTD. _____, its successors and assigns; and I/We will execute all papers necessary in connection with the United States applications and foreign applications when called upon to do so by the said _____ IPS LTD. _____, its successors or assigns, and that I/We will, at the cost and expense of the said _____ IPS LTD. _____, fully assist and cooperate in all matters in connection with the United States and foreign applications and patents issuing thereon.

The undersigned declare that all statements made herein of their own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: 4th April 2001 _____  _____ L.S.
Young-Hoon Park

Date: _____ _____ L.S.

Date: _____ _____ L.S.

Date: _____ _____ L.S.

Date: _____ _____ L.S.

Date: _____ _____ L.S.